



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**PCN#20191212001.2
New Tray for Select Devices
Final Change Notification**

Date: January 14, 2020
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require additional data to support your evaluation, please request within 30 days.

The changes discussed within this PCN will not take effect any earlier than **180** days from the date of this notification, unless customer agreement has been reached on an earlier implementation of the change. This notification period is per TI's standard process.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

20191212001.1
Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TPS9900TPZPQ1	null
TMS320F28075PZPQ	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20191212001.2		PCN Date:	Jan. 14, 2020	
Title:	New Tray for Select Devices				
Customer Contact:	PCN Manager	Dept:	Quality Services		
Proposed 1st Ship Date:	July 14, 2020				
Change Type:					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Assembly Materials
<input type="checkbox"/>	Design	<input type="checkbox"/>	Electrical Specification	<input type="checkbox"/>	Mechanical Specification
<input type="checkbox"/>	Test Site	<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials	<input type="checkbox"/>	Wafer Fab Process
	<input type="checkbox"/>	Part number change			

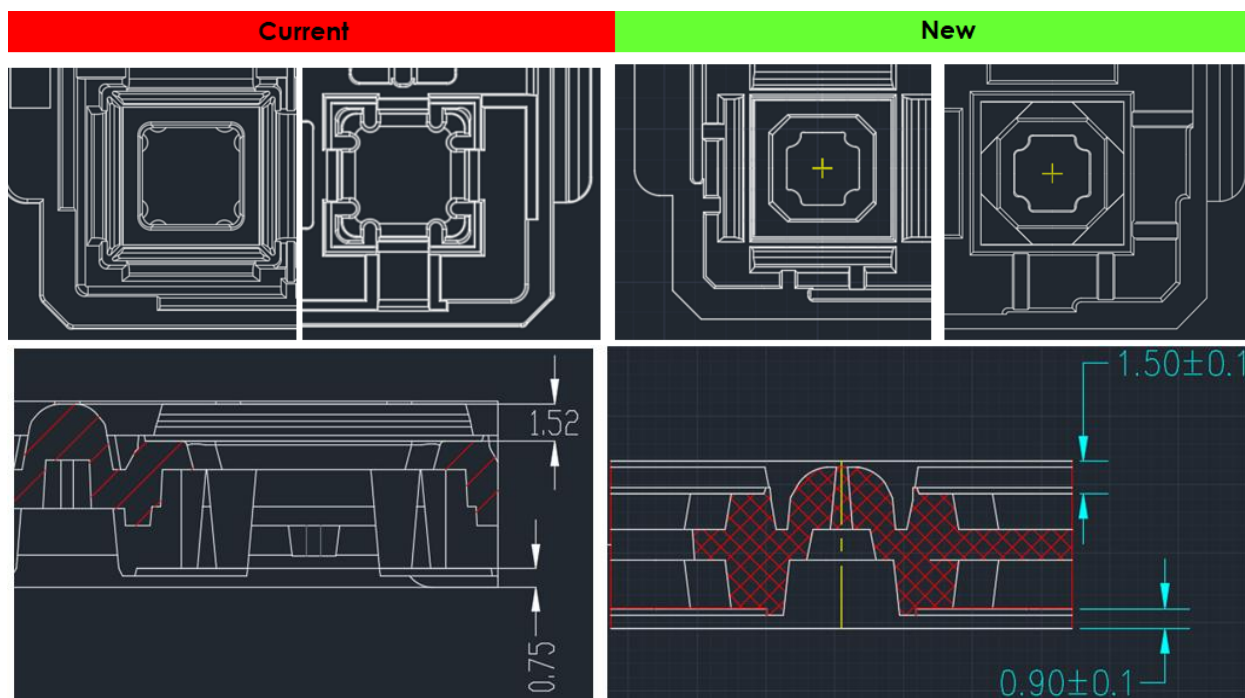
PCN Details

Description of Change:

Texas Instruments is pleased to announce the qualification of a new tray for the devices listed below. A comparison summary of the tray differences as follows:

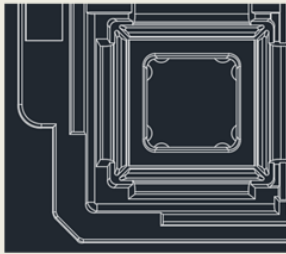
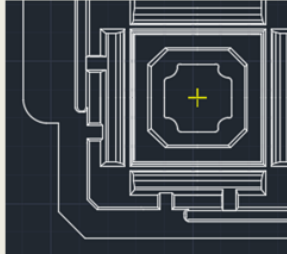
Group 1 Change Description - 14 x 14 TQFP Tray Change:

Tray Comparison Tables:



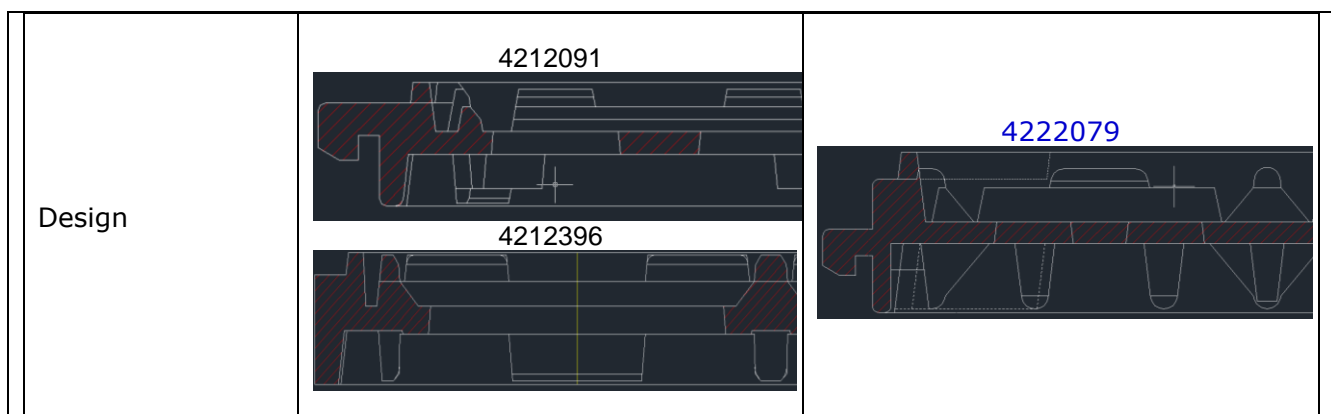
	4223432-0001	4224972-0001
Supplier	UBOT	Peak
Floor design	Circular square	Octagon
Cavity size	16.55 +/- 0.08	16.10 +/- 0.08
Seating height	1.52 mm (top) 0.75 mm (bottom)	1.5 mm(top) 0.9 mm (bottom)

Engineering Validation Results – Attribute Comparison

	EXISTING	PROPOSED	COMMENT
	4223432-0001	4224972-0001	CHANGE
* Supplier Part Number :	UQ1414 1.0 0615XB	ND 1414 1.0 0615 13 REV.G	CHANGE
* Gram Weight:	155	157	CHANGE
* Surface Resistivity :	10 ⁴ - 10 ¹⁰ ohm/sq	10 ⁴ - 10 ¹⁰ ohm/sq	UNCHANGE
* Package Size :	14x14x1.0	14x14x1.0	UNCHANGE
* Package Type :	TQFP	TQFP	UNCHANGE
Temperature Rating :	150C	150C	UNCHANGE
Matrix (Column X Rows) :	06x15	06x15	UNCHANGE
Fence design	Fillet	Fillet	UNCHANGE
Raw Material :	Carbon Fiber	Carbon Fiber	UNCHANGE
Color :	BLACK	BLACK	UNCHANGE
FLOOR DESIGN			CHANGE

Group 2 Change Description – 23 X 23 BGA Tray Change:

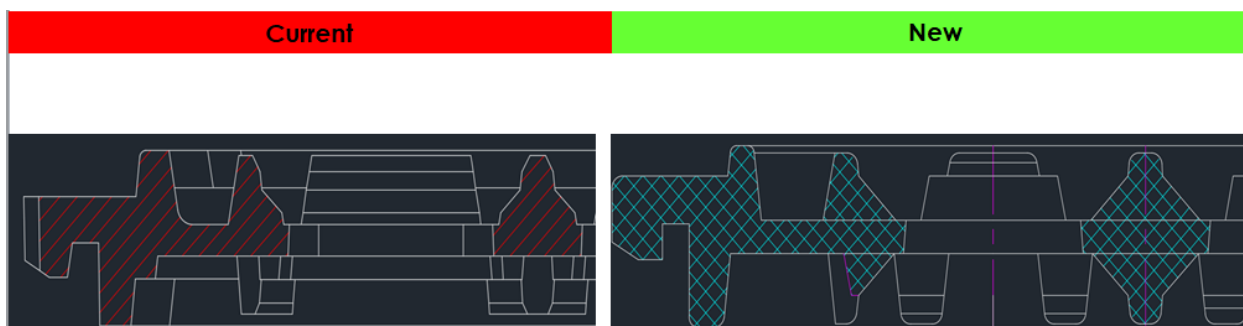
What	From	To
Stock #/Supplier	4212091/Daewan, 4212396/Kostat	4222079/Daewon
Weight	100/104 grams	169 grams
Thickness	7.62mm	12.19mm
Floor Design	"X", Square	"X"
Pocket Design	"X", Square	"X"



DIMENSIONAL COMPARISON

ITEM DESCRIPTION	CURRENT TRAY : 4212091-0001			CURRENT TRAY : 4212396-0001			PROPOSED: 4222079-0001			COMMENT
	DIM	Upper Limits	Lower Limits	DIM	Upper Limits	Lower Limits	DIM	Upper Limits	Lower Limits	
Overall Length	322.6	322.85	322.35	322.6	322.85	322.35	322.6	322.85	322.35	NO CHANGE
Layout Length	315.0	315.25	314.75	315.0	315.25	314.75	315.0	315.25	314.75	NO CHANGE
Layout Width	135.9	136.15	135.65	135.9	136.15	135.65	135.9	136.15	135.65	NO CHANGE
Layout Length on Top Stack frame	311.15	311.40	311.02	311.15	311.40	311.02	311.15	311.40	311.02	NO CHANGE
Layout Width on Top Stack frame	132.08	132.33	131.95	132.08	132.33	131.95	132.08	132.33	131.95	NO CHANGE
Layout Length on Bottom Stack frame	311.66	311.91	311.53	311.66	311.91	311.53	311.66	311.91	311.53	NO CHANGE
Layout Width on Bottom Stack frame	132.59	132.84	132.46	132.59	132.84	132.46	132.59	132.84	132.46	NO CHANGE
End Tab Length	92.1	92.35	91.85	92.1	92.35	91.85	92.1	92.35	91.85	NO CHANGE
Overall Height	7.62	7.75	7.49	7.62	7.75	7.49	12.19	12.32	12.06	CHANGE
Stack Height	1.27	1.40	1.14	1.27	1.40	1.14	2.03	2.16	1.90	CHANGE
Tray Matrix No.	5x12			5x12			5x12			NO CHANGE
Pitch M	16.95	17.08	16.82	16.95	17.08	16.82	16.95	17.08	16.82	NO CHANGE
Pitch M3	25.50	25.63	25.37	25.50	25.63	25.37	25.50	25.63	25.37	NO CHANGE
Pitch M1	17.25	17.38	17.12	17.25	17.38	17.12	17.25	17.38	17.12	NO CHANGE
Pitch M2	25.50	25.63	25.37	25.50	25.63	25.37	25.50	25.63	25.37	NO CHANGE
Distance of tray singulation from corner of tray	34.3	34.43	34.17	34.3	34.43	34.17	34.3	34.43	34.17	NO CHANGE
Tray singulation width	25.4	25.65	25.15	25.4	25.65	25.15	25.4	25.65	25.15	NO CHANGE
Tray Lifting surface height	2.54	2.67	2.41	2.54	2.67	2.41	2.54	2.67	2.41	CHANGE
Cavity Size	23.3	23.38	23.22	23.3	23.38	23.22	23.3	23.38	23.22	NO CHANGE
Pedestal Design	Slope design			Slope design			Slope design with corner relief			CHANGE
Package seating height (Top)	1.52	1.62	1.42	1.66	1.79	1.53	2.7	2.8	2.6	CHANGE
Package seating height (Bottom)	1.1	1.2	1	0.60	0.73	0.47	1.3	1.4	1.2	CHANGE

Group 3 Change Description - 13 x 13 BGA Tray Change:



	4212436-0001	4224857-0001
Supplier	UBOT	Peak
Tray Fence	Chamfered	Fillet
Cavity size (LSL)	13.30 + 0.08 13.30 - 0.04	13.30 + 0.08 13.30 - 0.08
Seating ht	1.64 mm (top) 2.00 mm (bottom)	1.27 mm(top) 1.37 mm (bottom)

MATERIAL DESCRIPTION	EXISTING	PROPOSED	COMMENT
	4212436-0001	4224857-0001	CHANGE
* Supplier Name :	UBOT	Peak	CHANGE
* Supplier Part Number :	UB13131.40820XB	NX BG1313 1.74 0820 13	CHANGE
* Gram Weight:	110	132.5	CHANGE
* Surface Resistivity :	1 exp5 - 1 exp11	1 exp5 - 1 exp11	NO CHANGE
* Package Size :	13x13	13x13	NO CHANGE
* Package Type :	BGA	BGA	NO CHANGE
Temperature Rating :	150C	150C	NO CHANGE
Matrix (Column X Rows) :	8x20	8x20	NO CHANGE
Raw Material :	Carbon fiber	Carbon fiber	NO CHANGE
Thickness :	7.62 mm	7.62	NO CHANGE
Color :	BLACK	BLACK	NO CHANGE
Floor Design	Yes	Yes	NO CHANGE

ITEM DESCRIPTION	4212436-0001 UB13131.40820XB			4224857-0001 NX BG1313 1.74 0820 13			COMMENT
	DIM	Upper Limits	Lower Limits	DIM	Upper Limits	Lower Limits	
Overall Length	322.6	322.85	322.35	322.6	322.85	322.35	NO CHANGE
Layout Length	315.0	315.25	314.75	315.0	315.25	314.75	NO CHANGE
Layout Width	135.9	136.15	135.65	135.9	136.15	135.65	NO CHANGE
Layout Length on Top Stack frame	311.15	311.40	311.02	311.15	311.40	311.02	NO CHANGE
Layout Width on Top Stack frame	132.08	132.33	131.95	132.08	132.33	131.95	NO CHANGE
Layout Length on Bottom Stack frame	311.66	311.91	311.53	311.66	311.91	311.53	NO CHANGE
Layout Width on Bottom Stack frame	132.59	132.84	132.46	132.59	132.84	132.46	NO CHANGE
End Tab Length	92.1	92.35	91.85	92.1	92.35	91.85	NO CHANGE
Overall Height	7.62	7.75	7.49	7.62	7.75	7.49	NO CHANGE
Stack Height	1.27	1.40	1.14	1.27	1.40	1.14	NO CHANGE
Tray Matrix No.	08x20			08x20			NO CHANGE
Pitch M	15.45	15.58	15.32	15.45	15.58	15.32	NO CHANGE
Pitch M3	15.00	15.13	14.87	15.00	15.13	14.87	NO CHANGE
Pitch M1	15.00	15.13	14.87	15.00	15.13	14.87	NO CHANGE
Pitch M2	15.00	15.13	14.87	15.00	15.13	14.87	NO CHANGE
Distance of tray singulation from corner of tray	34.30	34.55	34.05	34.30	34.55	34.05	NO CHANGE
Tray singulation width	25.40	25.53	25.27	25.40	25.53	25.27	NO CHANGE
Tray Lifting surface height	2.54	2.67	2.41	2.54	2.67	2.41	NO CHANGE
Cavity Size (X)	13.30	13.38	13.26	13.30	13.38	13.22	CHANGE
Cavity Size (Y)	13.30	13.38	13.26	13.30	13.38	13.22	CHANGE
Pedestal Design	SLOPE			SLOPE			NO CHANGE
Package seating height (Top)	1.64	1.71	1.57	1.27	1.37	1.17	CHANGE
Package seating height (Bottom)	2.00	2.05	1.92	1.35	1.45	1.25	CHANGE

Reason for Change:
New tray offers improved centering of device in tray pocket
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):
None

Changes to product identification resulting from this PCN:

New tray

Product Affected:

Group 1 Device list:

PCOBCG904NBNPNP	PTPS99000ACPZP	TMS320F28069FPZPQ	TMS320F28377SPZPQ
PCOBRG904PNPR	TMS320F28062PZPQ	TMS320F28069MPZPQ	TPS9900TPZPQ1
PCOBRG904PNQ	TMS320F28065PZPQ	TMS320F28069PZPQ	TPS9901TPZPQ1
PTPS99000AAPZP	TMS320F28066PZPQ	TMS320F28075PZPQ	TVP5158IPNPQ1
PTPS99000ABPZP	TMS320F28067PZPQ	TMS320F28375SPZPQ	

Group 2 Device list:

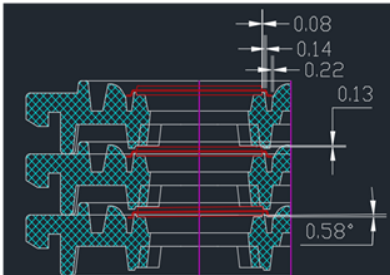
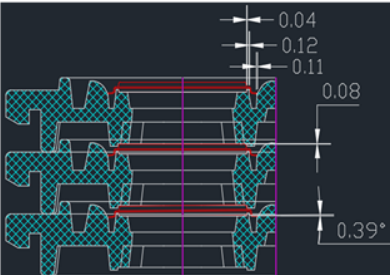
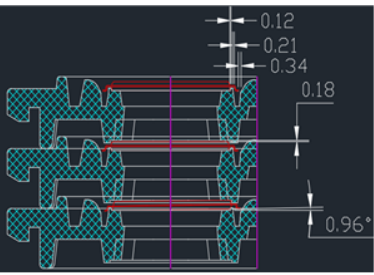
TDA2HFBTQABCQ1	XDRA726BXDEABC	XDRA726BXGABC	XDRA726BXGABCH
TDA2SABRQABCQ1			

Group 3 Device list:

OMAPL138EZCEQ4

Group 1 Device Fit Analysis:

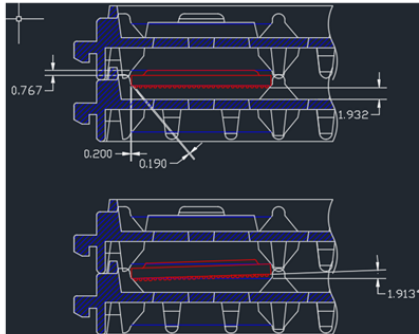
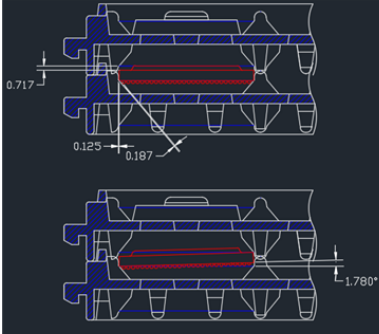
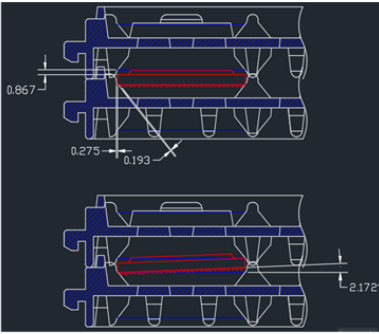
FIT ANALYSIS

PKG	NOMINAL TRAY vs NOMINAL PACKAGE	MINIMUM TRAY MAXIMUM PACKAGE	MAXIMUM TRAY vs MINIMUM PACKAGE
PZP, PDT, PNP, NEZ, PZT			

- X and Y clearance is not greater than 0.5 mm
- Rotation angle is less than 10 degrees

Group 2 Device Fit Analysis:

FIT ANALYSIS

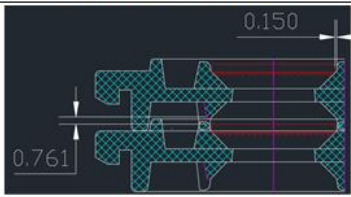
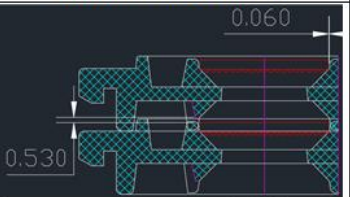
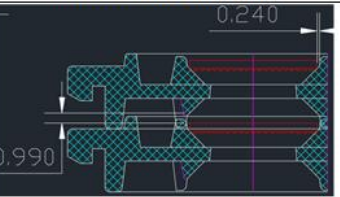

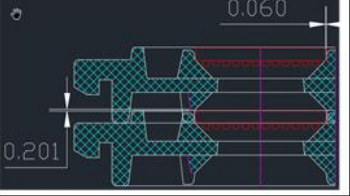
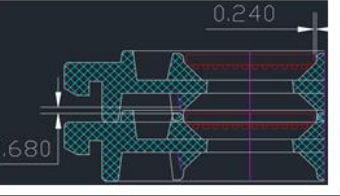



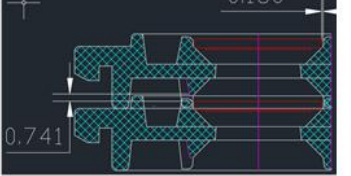
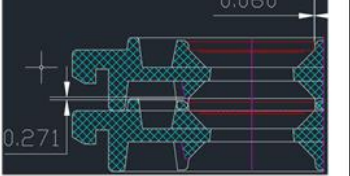

	NOMINAL TRAY vs NOMINAL PKG	TRAY MINIMUM vs PACKAGE MAXIMUM	TRAY MAXIMUM vs PACKAGE MINIMUM
IC			

REMARKS:

- ❖ X and Y clearance is less than 0.5mm
- ❖ Rotation angle is less than 10 degrees

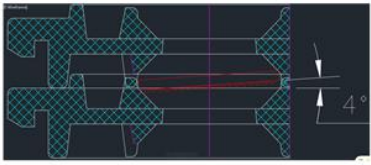
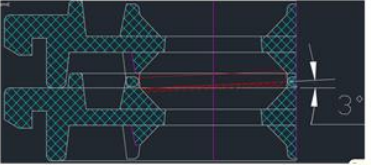
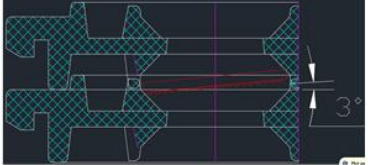
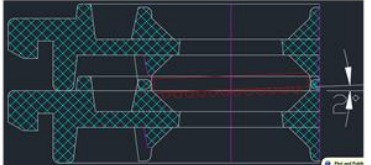
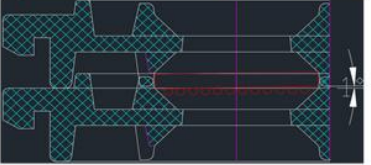
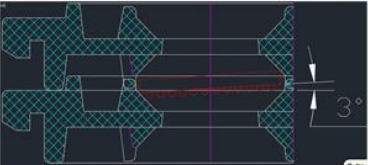
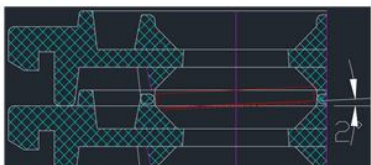
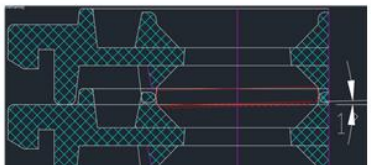
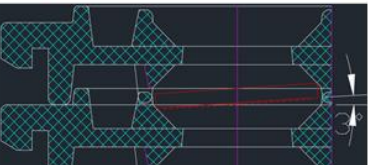
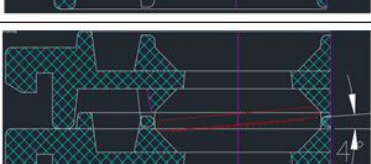
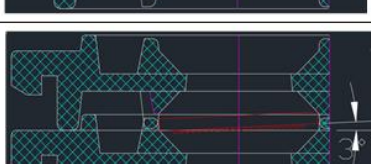

Group 3 Device Fit Analysis:

FIT ANALYSIS

PACKAGE	NOMINAL TRAY vs NOMINAL PACKAGE	TRAY MINIMUM vs PACKAGE MAXIMUM	TRAY MAXIMUM vs PACKAGE MINIMUM
ZCE/GCE			
ZWQ			
ZXK			
ZAA			

- X and Y clearance is not greater than 5 mm

FIT ANALYSIS

PACKAGE	NOMINAL TRAY vs NOMINAL PACKAGE	TRAY MINIMUM vs PACKAGE MAXIMUM	TRAY MAXIMUM vs PACKAGE MINIMUM
ZCE/GCE			
ZWQ			
ZXK			
ZAA			

- Angle is less than 10degrees

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For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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